Video Amplifier

The NE592 is a monolithic, two-stage, differential output, wideband video amplifier. It offers fixed gains of 100 and 400 without external components and adjustable gains from 400 to 0 with one external resistor. The input stage has been designed so that with the addition of a few external reactive elements between the gain select terminals, the circuit can function as a high-pass, low-pass, or band-pass filter. This feature makes the circuit ideal for use as a video or pulse amplifier in communications, magnetic memories, display, video recorder systems, and floppy disk head amplifiers. Now available in an 8-pin version with fixed gain of 400 without external components and adjustable gain from 400 to 0 with one external resistor.

Features

- 120 MHz Unity Gain Bandwidth
- Adjustable Gains from 0 to 400
- Adjustable Pass Band
- No Frequency Compensation Required
- Wave Shaping with Minimal External Components
- MIL-STD Processing Available
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Floppy Disk Head Amplifier
- Video Amplifier
- Pulse Amplifier in Communications
- Magnetic Memory
- Video Recorder Systems

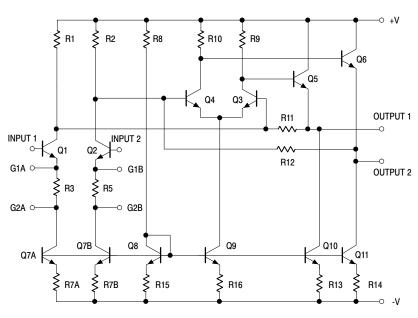


Figure 1. Block Diagram



ON Semiconductor®

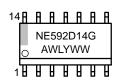
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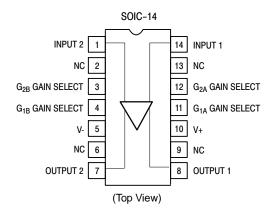
A = Assembly Location

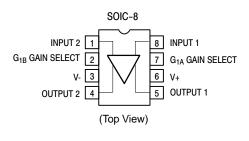
L, WL = Wafer Lot Y = Year W, WW = Work Week ■ or G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

PIN CONNECTIONS





MAXIMUM RATINGS ($T_A = +25^{\circ}C$, unless otherwise noted.)

Rating	Symbol	Value	Unit	
Supply Voltage		V _{CC}	±8.0	V
Differential Input Voltage		V _{IN}	±5.0	V
Common-Mode Input Voltage		V _{CM}	±6.0	V
Output Current		I _{OUT}	10	mA
Operating Ambient Temperature Range		T _A	0 to +70	°C
Operating Junction Temperature		T _J	150	°C
Storage Temperature Range		T _{STG}	65 to +150	°C
Maximum Power Dissipation, $T_A = 25^{\circ}C$ (Still Air) (Note 1)	SOIC-14 Package SOIC-8 Package	P _{D MAX}	0.98 0.79	W
Thermal Resistance, Junction–to–Ambient	SOIC-14 Package SOIC-8 Package	$R_{ heta JA}$	145 182	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Derate above 25°C at the following rates:
 SOIC-14 package at 6.9 mW/°C
 SOIC-8 package at 5.5 mW/°C

DC ELECTRICAL CHARACTERISTICS ($V_{SS} = \pm 6.0 \text{ V}$, $V_{CM} = 0$, typicals at $T_A = +25^{\circ}\text{C}$, min and max at $0^{\circ}\text{C} \leq T_A \leq 70^{\circ}\text{C}$, unless otherwise noted. Recommended operating supply voltages $V_S = \pm 6.0 \text{ V}$.)

Characteristic	Test Conditions	Symbol	Min	Тур	Max	Unit
Differential Voltage Gain Gain 1 (Note 2) Gain 2 (Notes 3 and 4)	$R_L = 2.0 \text{ k}\Omega, V_{OUT} = 3.0 \text{ V}_{P-P}$	A _{VOL}	250 80	400 100	600 120	V/V
Input Resistance Gain 1 (Note 2) Gain 2 (Notes 3 and 4)	$T_{A} = 25^{\circ}C$ $0^{\circ}C \le T_{A} \le 70^{\circ}C$	R _{IN}	- 10 8.0	4.0 30 -	- - -	kΩ
Input Capacitance	Gain 2 (Note 4)	C _{IN}	_	2.0	_	pF
Input Offset Current	$T_A = 25^{\circ}C$ $0^{\circ}C \le T_A \le 70^{\circ}C$	los	_ _	0.4	5.0 6.0	μΑ
Input Bias Current	$T_A = 25^{\circ}C$ $0^{\circ}C \le T_A \le 70^{\circ}C$	I _{BIAS}	_ _	9.0	30 40	μΑ
Input Noise Voltage	BW 1.0 kHz to 10 MHz	V _{NOISE}	_	12	-	μV_{RMS}
Input Voltage Range	-	V _{IN}	±1.0	_	-	V
Common-Mode Rejection Ratio Gain 2 (Note 4)	$V_{CM} \pm 1.0 \text{ V, f} < 100 \text{ kHz, T}_{A} = 25^{\circ}\text{C}$ $V_{CM} \pm 1.0 \text{ V, f} < 100 \text{ kHz,}$ $0^{\circ}\text{C} \le T_{A} \le 70^{\circ}\text{C}$	CMRR	60 50	86 -	_ _	dB
	$V_{CM} \pm 1.0 \text{ V, f} < 5.0 \text{ MHz}$		_	60	_	
Supply Voltage Rejection Ratio Gain 2 (Note 4)	$\Delta V_S = \pm 0.5 \text{ V}$	PSRR	50	70	_	dB
Output Offset Voltage Gain 1 Gain 2 (Note 4) Gain 3 (Note 5) Gain 3 (Note 5)	$R_{L} = \infty$ $R_{L} = \infty$ $R_{L} = \infty$ $R_{L} = \infty, T_{A} = 25^{\circ}C$ $R_{L} = \infty, 0^{\circ}C \leq T_{A} \leq 70^{\circ}C$	Vos	- - - -	- - 0.35 -	1.5 1.5 0.75 1.0	V
Output Common-Mode Voltage	R _L = ∞, T _A = 25°C	V _{CM}	2.4	2.9	3.4	V
Output Voltage Swing Differential	$R_L = 2.0 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$ $R_L = 2.0 \text{ k}\Omega, 0^{\circ}\text{C} \le T_A \le 70^{\circ}\text{C}$	V _{OUT}	3.0 2.8	4.0	- -	V
Output Resistance	-	R _{OUT}	_	20	-	Ω
Power Supply Current	$\begin{aligned} R_L &= \infty \text{, } T_A = 25^{\circ}\text{C} \\ R_L &= \infty \text{, } 0^{\circ}\text{C} \leq T_A \leq 70^{\circ}\text{C} \end{aligned}$	Icc	- -	18 -	24 27	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS (T_A = +25°C V_{SS} = ± 6.0 V, V_{CM} = 0, unless otherwise noted. Recommended operating supply voltages $V_S = \pm 6.0 \text{ V.}$)

Characteristic	Test Conditions	Symbol	Min	Тур	Max	Unit
Bandwidth Gain 1 (Note 2) Gain 2 (Notes 3 and 4)	-	BW	_ _	40 90	_ _	MHz
Rise Time Gain 1 (Note 2) Gain 2 (Notes 3 and 4)	V _{OUT} = 1.0 V _{P-P}	t _R	_ _	10.5 4.5	12 -	ns
Propagation Delay Gain 1 (Note 2) Gain 2 (Notes 3 and 4)	V _{OUT} = 1.0 V _{P-P}	t _{PD}	_ _	7.5 6.0	10 -	ns

- Gain select Pins G_{1A} and G_{1B} connected together.
 Gain select Pins G_{2A} and G_{2B} connected together.
 Applies to 14-pin version only.
 All gain select pins open.

TYPICAL PERFORMANCE CHARACTERISTICS

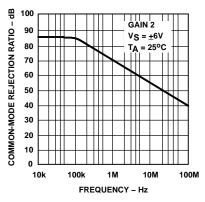


Figure 2. Common–Mode Rejection Ratio as a Function of Frequency

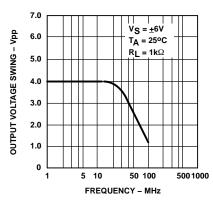


Figure 3. Output Voltage Swing as a Function of Frequency

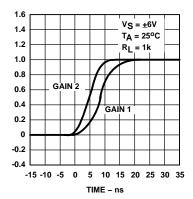


Figure 4. Pulse Response

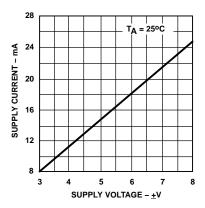


Figure 5. Supply Current as a Function of Temperature

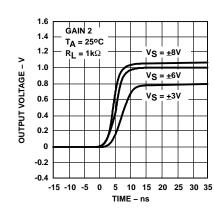


Figure 6. Pulse Response as a Function of Supply Voltage

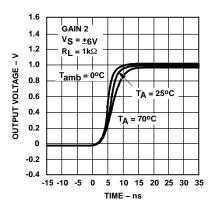


Figure 7. Pulse Response as a Function of Temperature

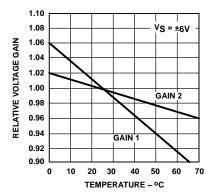


Figure 8. Voltage Gain as a Function of Temperature

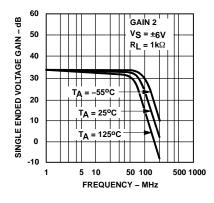


Figure 9. Gain vs. Frequency as a Function of Temperature

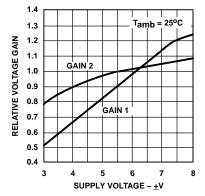


Figure 10. Voltage Gain as a Function of Supply Voltage

TYPICAL PERFORMANCE CHARACTERISTICS

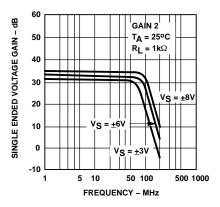


Figure 11. Gain vs. Frequency as a Function of Supply Voltage

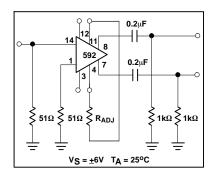


Figure 12. Voltage Gain Adjust Circuit

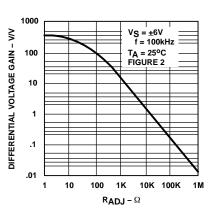


Figure 13. Voltage Gain as a Function of RADJ (Figure 2)

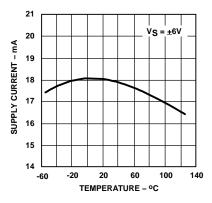


Figure 14. Supply Current as a Function of Temperature

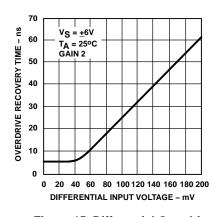


Figure 15. Differential Overdrive Recovery Time

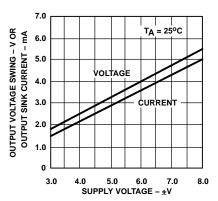


Figure 16. Output Voltage and Current Swing as a Function of Supply Voltage

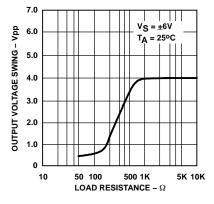


Figure 17. Output Voltage Swing as a Function of Load Resistance

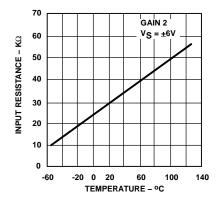


Figure 18. Input Resistance as a Function of Temperature

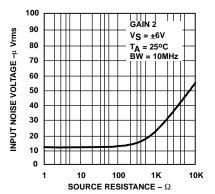


Figure 19. Input Noise Voltage as a Function of Source
Resistance

TYPICAL PERFORMANCE CHARACTERISTICS

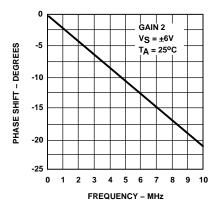


Figure 20. Phase Shift as a Function of Frequency

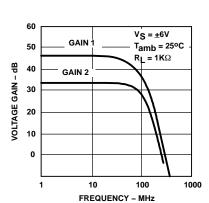


Figure 22. Voltage Gain as a Function of Frequency

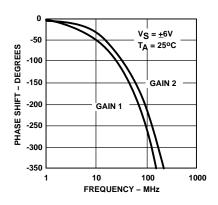


Figure 21. Phase Shift as a Function of Frequency

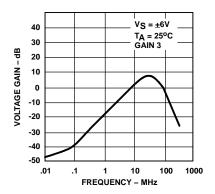


Figure 23. Voltage Gain as a Function of Frequency

TEST CIRCUITS ($T_A = 25^{\circ}C$, unless otherwise noted.)

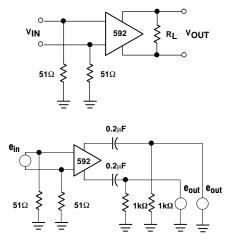


Figure 24. Test Circuits

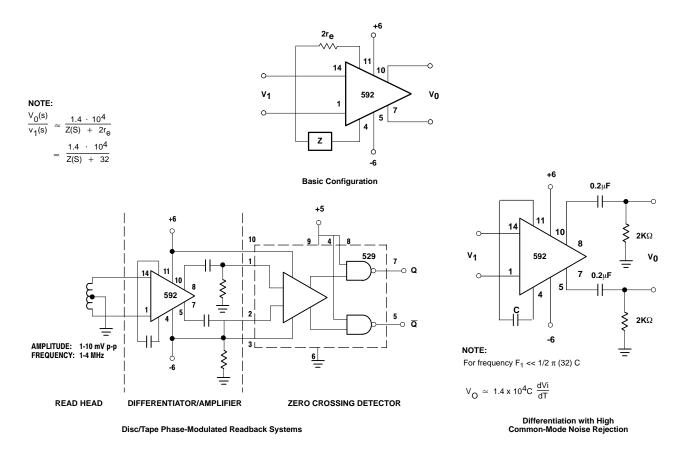


Figure 25. Typical Applications

Z NETWORK	FILTER TYPE	V ₀ (s) TRANSFER V ₁ (s) FUNCTION
oo	LOW PASS	$\frac{1.4 \times 10^4}{L} \left[\frac{1}{s + R/L} \right]$
R C ○	HIGH PASS	$\frac{1.4 \times 10^4}{R} \left[\frac{s}{s + 1/RC} \right]$
R L C	BAND PASS	$\frac{1.4 \times 10^4}{L} \left[\frac{s}{s^2 + R/Ls + 1/LC} \right]$
R C C	BAND REJECT	$\frac{1.4 \times 10^4}{R} \left[\frac{s^2 + 1/LC}{s^2 + 1/LC + s/RC} \right]$

NOTES:

In the networks above, the R value used is assumed to include $2r_{\hbox{\it e}},$ or approximately $32\Omega.$ S = $j\Omega$ Ω = $2\pi f$

Figure 26. Filter Networks

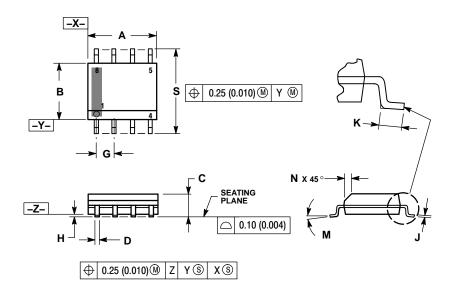
ORDERING INFORMATION

Device	Temperature Range	Package	Shipping [†]
NE592D8G		SOIC-8 (Pb-Free)	98 Units/Rail
NE592D8R2G	0.47000		2500 / Tape & Reel
NE592D14G	0 to +70°C	SOIC-14	55 Units/Rail
NE592D14R2G		(Pb-Free)	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

PACKAGE DIMENSIONS

SOIC-8 NB CASE 751-07 **ISSUE AK**



NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.

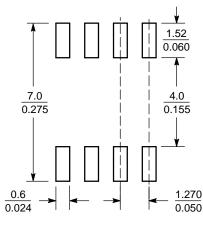
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.

 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

 6. 751—01 THRU 751—06 ARE OBSOLETE. NEW STANDARD IS 751—07.

	MILLIMETERS		INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	4.80	5.00	0.189	0.197		
В	3.80	4.00	0.150	0.157		
С	1.35	1.75	0.053	0.069		
D	0.33	0.51	0.013	0.020		
G	1.27	1.27 BSC		0.050 BSC		
Н	0.10	0.25	0.004	0.010		
J	0.19	0.25	0.007	0.010		
K	0.40	1.27	0.016	0.050		
М	0 °	8 °	0 °	8 °		
N	0.25	0.50	0.010	0.020		
S	5.80	6.20	0.228	0.244		

SOLDERING FOOTPRINT*

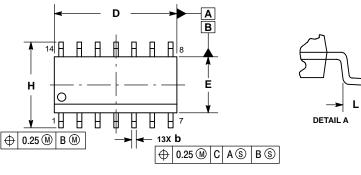


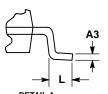
 $\left(\frac{\text{mm}}{\text{inches}}\right)$ SCALE 6:1

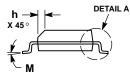
^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

SOIC-14 CASE 751A-03 **ISSUE L**





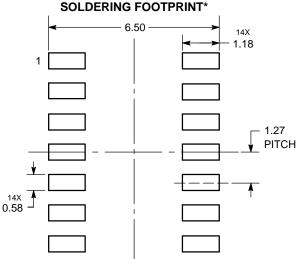


- 1. DIMENSIONING AND TOLERANCING PER
- DIMENSIONING AND TOLERANCING PER ASME 714.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT
- MAXIMUM MATERIAL CONDITION.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.

 5. MAXIMUM MOLD PROTRUSION 0.15 PER

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.35	1.75	0.054	0.068
A1	0.10	0.25	0.004	0.010
A3	0.19	0.25	0.008	0.010
b	0.35	0.49	0.014	0.019
D	8.55	8.75	0.337	0.344
Е	3.80	4.00	0.150	0.157
е	1.27	BSC	0.050	BSC
Н	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.019
L	0.40	1.25	0.016	0.049
M	0 °	7 °	0°	7 °

SEATING PLANE С



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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0.10

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N. American Technical Support: 800-282-9855 Toll Free USA/Canada

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Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

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